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The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

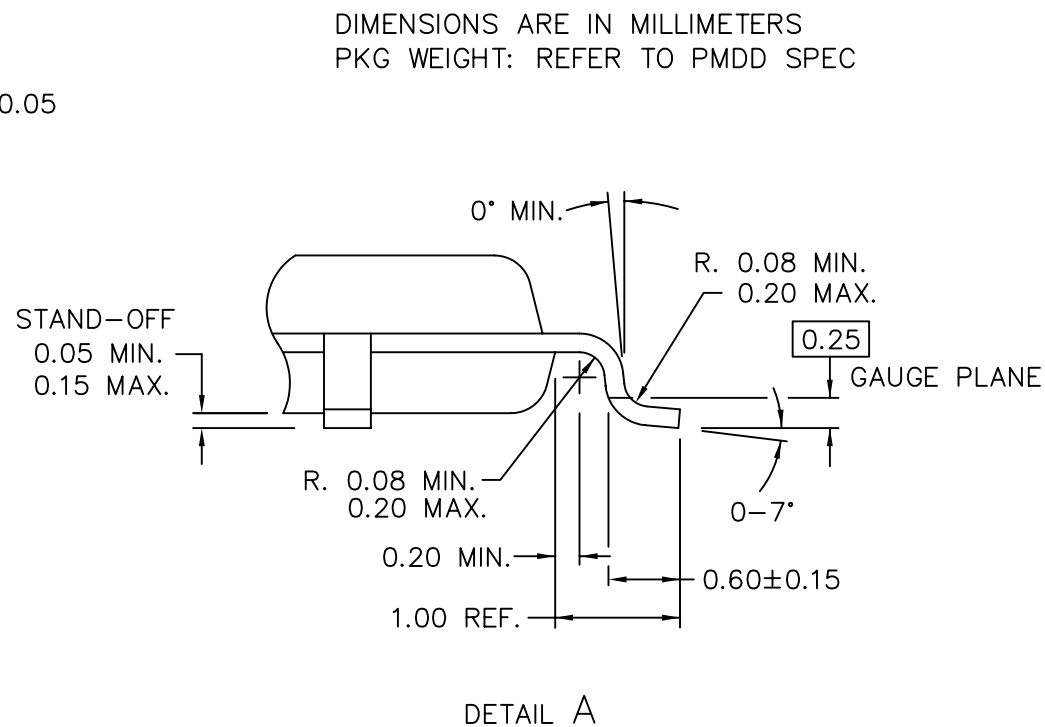
Continuity of document content



The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

Continuity of ordering part numbers

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

REVISIONS						
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE	APPROVED
1	-	**	47074	NEW RELEASE	11/01/96	N/A
1	-	*A	49488	CHANGE TITLE	03/26/97	N/A
1	-	*B	115051	REACTIVATE SPEC.	04/23/02	N/A
1	-	*C	2833453	Changed template, & title from 32LD TQFP (7 X 7 X 1.4) PKG OUTLINE to PACKAGE OUTLINE, 32LD TQFP 7X7X1.4 MM A3214.	12/28/09	QAD
1	-	*D	3352919	UPDATE SPECS FOR SUNSET REVIEW. NO CHANGE.	08/24/11	QAD
1	-	*E	3722534	ADDED "PKG WEIGHT: REFER TO PMDD SPEC".	08/24/12	QAD



UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE IN MILLIMETERS STANDARD TOLERANCES ON:		DESIGNED BY HTN		DATE 04/23/02		 CYPRESS Company Confidential							
DECIMALS .XX ± 0.05 .XXX ± .XXXX +		ANGLES ± 1°		DRAWN BY HTN		DATE 04/23/02		TITLE PACKAGE OUTLINE, 32LD TQFP 7X7X1.4 MM A3214					
		CHECKED BY EDCA		DATE 08/24/12									
		APPROVED BY ZZQ		DATE 08/24/12									
MATERIAL N/A		APPROVED BY QAD		DATE 08/24/12		SIZE A		PART NO. A3214		DWG NO 51-85088		REV *E	
FINISH N/A		APPROVED BY CMG		DATE 08/24/12		SCALED TO FIT		N/A		SHEET 1		OF 1	

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